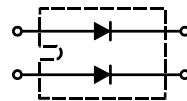


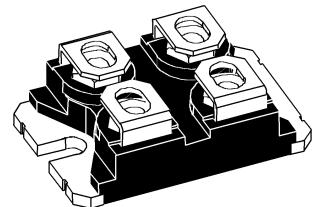
# Power Schottky Rectifier

**I<sub>FAV</sub>** = 2x120 A  
**V<sub>RRM</sub>** = 45 V  
**V<sub>F</sub>** = 0.59 V

V <sub>RSM</sub> V	V <sub>RRM</sub> V	Type
45	45	DSS 2x121-0045B



miniBLOC, SOT-227 B



Symbol	Conditions	Maximum Ratings		
I <sub>FRMS</sub>		150	A	
I <sub>FAVM</sub>	T <sub>C</sub> = 100°C; rectangular, d = 0.5	120	A	
I <sub>FAVM</sub>	T <sub>C</sub> = 100°C; rectangular, d = 0.5; per device	240	A	
I <sub>FSM</sub>	T <sub>VJ</sub> = 45°C; t <sub>p</sub> = 10 ms (50 Hz), sine	1600	A	
E <sub>AS</sub>	I <sub>AS</sub> = 28 A; L = 180 µH; T <sub>VJ</sub> = 25°C; non repetitive	112	mJ	
I <sub>AR</sub>	V <sub>A</sub> = 1.5 • V <sub>RRM</sub> typ.; f=10 kHz; repetitive	2.8	A	
(dV/dt) <sub>cr</sub>		1000	V/µs	
T <sub>VJ</sub>		-40...+150	°C	
T <sub>VJM</sub>		150	°C	
T <sub>stg</sub>		-40...+150	°C	
P <sub>tot</sub>	T <sub>C</sub> = 25°C	310	W	
V <sub>ISOL</sub>	50/60 Hz, RMS I <sub>ISOL</sub> ≤ 1 mA	2500	V~	
M <sub>d</sub>	mounting torque (M4) terminal connection torque (M4)	1.1-1.5/9-13 1.1-1.5/9-13	Nm/lb.in. Nm/lb.in.	
Weight	typical	30	g	

Symbol	Conditions	Characteristic Values		
		typ.	max.	
I <sub>R</sub> ①	T <sub>VJ</sub> = 25°C V <sub>R</sub> = V <sub>RRM</sub> T <sub>VJ</sub> = 100°C V <sub>R</sub> = V <sub>RRM</sub>	120 500	mA mA	
V <sub>F</sub>	I <sub>F</sub> = 120 A; T <sub>VJ</sub> = 125°C I <sub>F</sub> = 120 A; T <sub>VJ</sub> = 25°C I <sub>F</sub> = 240 A; T <sub>VJ</sub> = 125°C	0.59 0.62 0.97	V V V	
R <sub>thJC</sub> R <sub>thCH</sub>		0.1	0.4 K/W K/W	

Pulse test: ① Pulse Width = 5 ms, Duty Cycle < 2.0 %  
Data according to IEC 60747 and per diode unless otherwise specified

IXYS reserves the right to change limits, Conditions and dimensions.

Dimensions see outlines.pdf

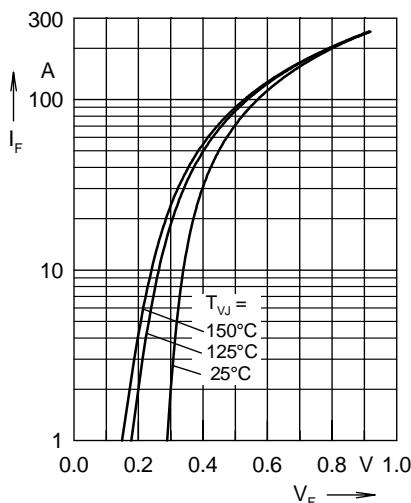


Fig. 1 Maximum forward voltage drop characteristics

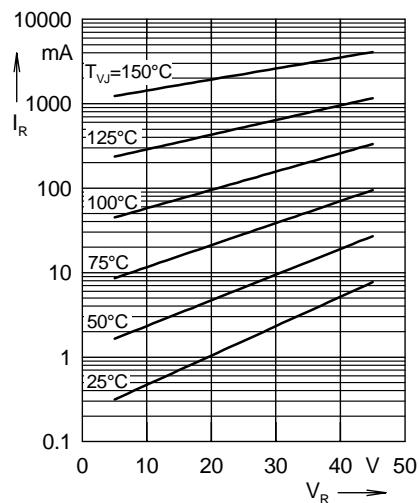


Fig. 2 Typ. value of reverse current  $I_R$  versus reverse voltage  $V_R$

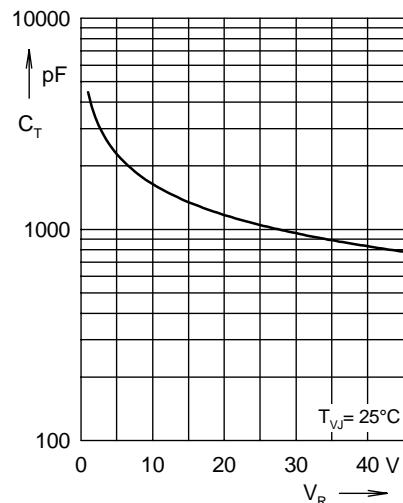


Fig. 3 Typ. junction capacitance  $C_T$  versus reverse voltage  $V_R$

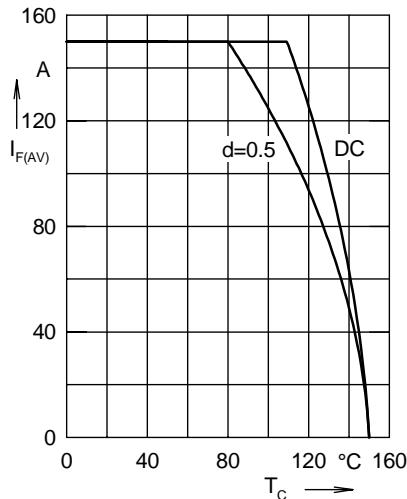


Fig. 4 Average forward current  $I_{F(AV)}$  versus case temperature  $T_C$

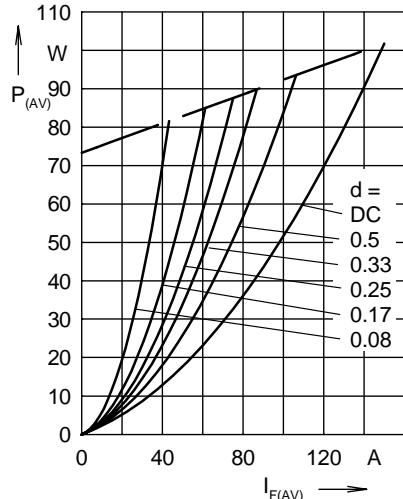


Fig. 5 Forward power loss characteristics

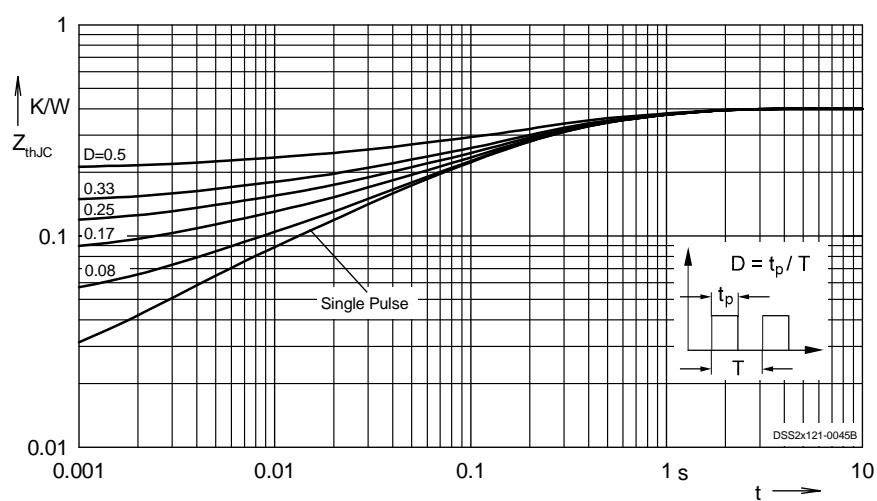


Fig. 6 Transient thermal impedance junction to case at various duty cycles

Note: All curves are per diode